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April 1st, 2010 Renesas Electronics Corporation

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NP88N04KUG

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The NP88N04KUG is N-channel MOS Field Effect
Transistor designed for high current switching applications.

ORDERING INFORMATION

PART NUMBER	PACKAGE
NP88N04KUG	TO-263 (MP-25ZK)

FEATURES

- Channel temperature 175 degree rating
- Super low on-state resistance $R_{DS(on)} = 2.9\,m\Omega\;MAX.\;(V_{GS} = 10\,V,\;I_{D} = 44\,A)$

• Low C_{iss}: C_{iss} = 10000 pF TYP.

(TO-263)



ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vss = 0 V)	VDSS	40	V
Gate to Source Voltage (Vps = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	I _{D(DC)}	±88	Α
Drain Current (pulse) Note1	D(pulse)	±352	Α
Total Power Dissipation (T _A = 25°C)	P _{T1}	1.8	W
Total Power Dissipation (Tc = 25°C)	P _{T2}	200	W
Channel Temperature	Tch	175	°C
Storage Temperature	T _{stg}	-55 to +175	°C
Repetitive Avalanche Current Note2	lar	56	Α
Repetitive Avalanche Energy Note2	Ear	314	mJ

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Tch \leq 150°C, VDD = 20 V, Rg = 25 Ω , Vgs = 20 \rightarrow 0 V

THERMAL RESISTANCE

Channel to Case Thermal Resistance	Rth(ch-C)	0.75	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)	83.3	°C/W

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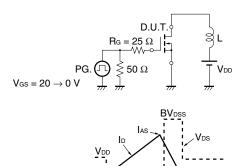


ELECTRICAL CHARACTERISTICS (TA = 25°C)

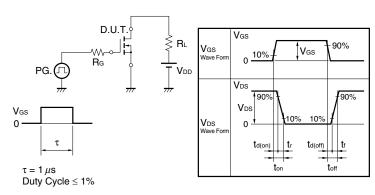
		·		1		
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ipss	V _{DS} = 40 V, V _{GS} = 0 V			1	μΑ
Gate Leakage Current	Igss	V _{GS} = ±20 V, V _{DS} = 0 V			±100	nA
Gate to Source Threshold Voltage Note	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	2.0	3.0	4.0	V
Forward Transfer Admittance Note	y fs	V _{DS} = 10 V, I _D = 44 A	27	55		S
Drain to Source On-state Resistance Note	RDS(on)	V _{GS} = 10 V, I _D = 44 A		2.3	2.9	mΩ
Input Capacitance	Ciss	V _{DS} = 25 V		10000	15000	pF
Output Capacitance	Coss	V _{GS} = 0 V		910	1370	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		550	990	pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = 20 V, I _D = 44 A		43	100	ns
Rise Time	tr	V _{GS} = 10 V		104	260	ns
Turn-off Delay Time	td(off)	R _G = 0 Ω		107	220	ns
Fall Time	tf			22	60	ns
Total Gate Charge	Q _G	V _{DD} = 32 V		165	250	nC
Gate to Source Charge	Qgs	V _{GS} = 10 V		45		nC
Gate to Drain Charge	Q _{GD}	I _D = 88 A		55		nC
Body Diode Forward Voltage Note	V _{F(S-D)}	I _F = 88 A, V _{GS} = 0 V		0.91	1.5	V
Reverse Recovery Time	trr	I _F = 88 A, V _{GS} = 0 V		51		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		66		nC

Note Pulsed

TEST CIRCUIT 1 AVALANCHE CAPABILITY



TEST CIRCUIT 2 SWITCHING TIME



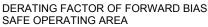
TEST CIRCUIT 3 GATE CHARGE

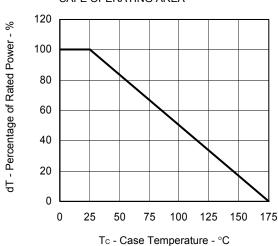
PG.
$$\bigcirc$$
 S 50 Ω \bigcirc Voc

Starting Tch

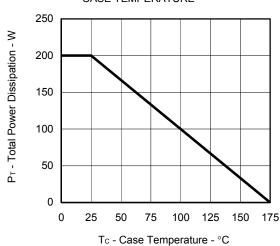


TYPICAL CHARACTERISTICS (TA = 25°C)

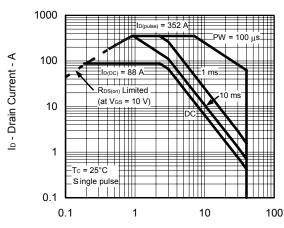




TOTAL POWER DISSIPATION vs. CASE TEMPERATURE

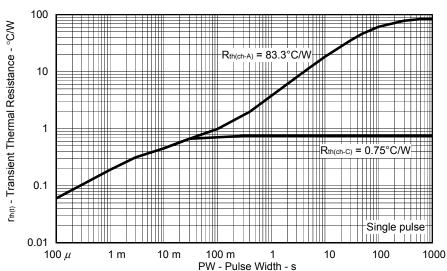


FORWARD BIAS SAFE OPERATING AREA



VDS - Drain to Source Voltage - V

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



Data Sheet D16855EJ1V0DS

3



0

Vos(th) - Gate to Source Threshold Voltage - V

0.2

Pulsed

0.4

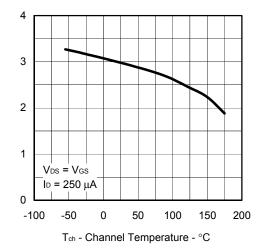
DRAIN CURRENT vs.

GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE

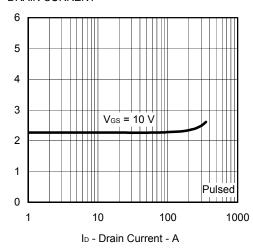
VDS - Drain to Source Voltage - V

0.6

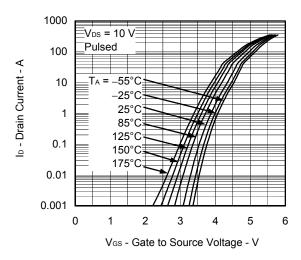
8.0



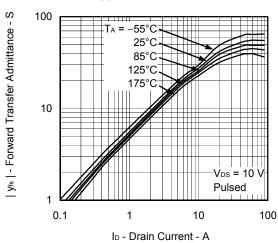
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



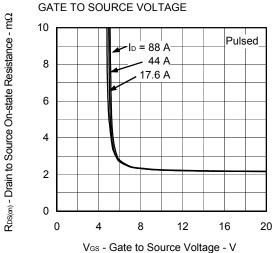
FORWARD TRANSFER CHARACTERISTICS



FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

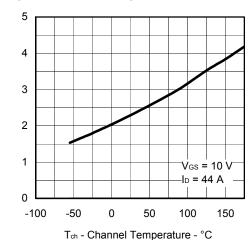


RDS(m) - Drain to Source On-state Resistance - m\Omega

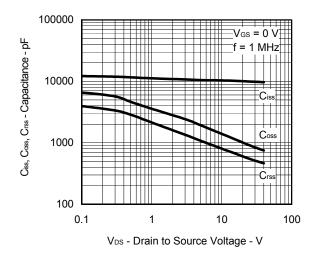


RDS(on) - Drain to Source On-state Resistance - m\Omega

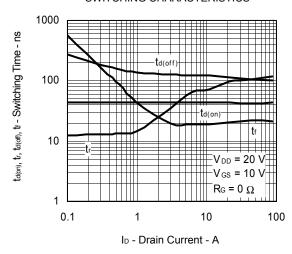
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



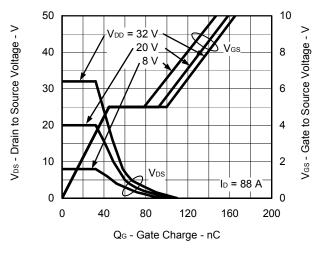
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



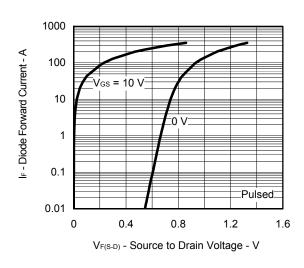
SWITCHING CHARACTERISTICS



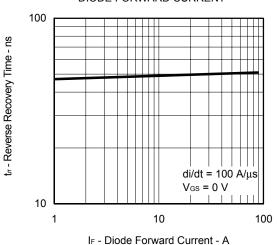
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE

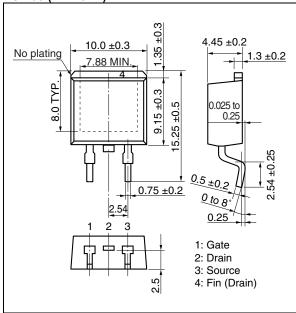


REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT

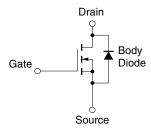


PACKAGE DRAWING (Unit: mm)

TO-263 (MP-25ZK)



EQUIVALENT CIRCUIT



Remark Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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